

1.6 x 0.8x 0.6mm Red & White Chip LED

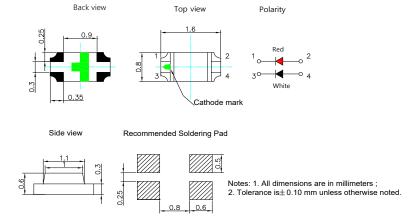
OSRW1608C1C

Features

- **Bi-Color**
- Super high brightness of surface mount LED
- Yellow diffused flat mold
- Compact package outline (LxWxT) of 1.6mm x 0.8mm x 0.6mm
- Compatible to IR reflow soldering.

Applications

- Backlighting (switches, keys, etc.)
- Marker lights (e.g. steps, exit ways, etc.)



The new EU chemicals I

Outline Dimension

Absolute Maximum Rating

Item

DC Forward Current

Reverse Voltage

Power Dissipation

Operating Temperature

Lead Soldering Temperature

Storage Temperature

Pulse Forward Current#

(Ta=25°C)

W

20

100

5

66

V

°C

°C

Value

-40 ~ +85

 $-40 \sim +85$

260°C/10sec

R

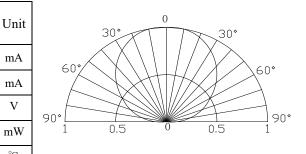
20

100

5

46

Directivity



#Pulse width Max 0.1ms, Duty ratio max 1/10

■ Electrical - Optical Characteristics (Ta=25°C)

Symbol

IF

IFP

VR

 \mathbf{P}_{D}

Topr

Tstg

Tsol

			$V_{F}(V)$		$I_R(\mu A)$	-	Iv(mcd))	λD(1	nm)/CC	T(K)	201/2(deg)	
Part Number	Color		Min.	Тур.	Max.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Тур.
			I _F =5mA			$V_R=5V$	I _F =5mA						
OSDW1(09C1C	Red		-	1.7	2.3	10	30	50	-	620	625	630	120
OSRW1608C1C	White		-	2.7	3.3	10	100	150	-	10000-	18000-2	25000K	K 120

*1 Tolerance of measurements of dominant wavelength is +1nm

*2 Tolerance of measurements of luminous intensity is $\pm 15\%$

*3 Tolerance of measurements of forward voltage is±0.1V

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CNAS

ATTENTION

OBSERVE PRECAUTIO ELECTROSTATIC

SITIVE DEVICES



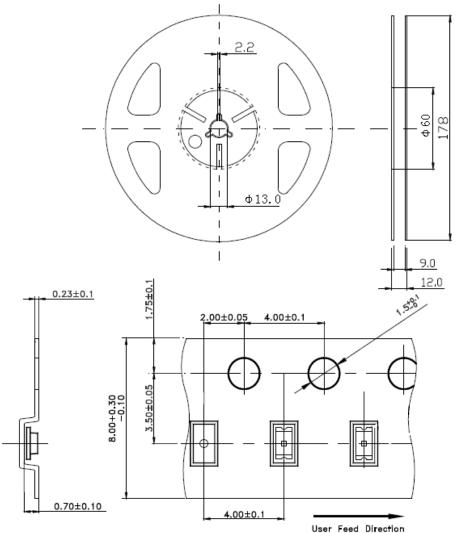
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Reel & Tape Dimensions

Quantity: 4,000 units/reel

Diameter: 178 mm



Notes: 1. All dimensions are in millimeters ;

ISO 9001: 2008

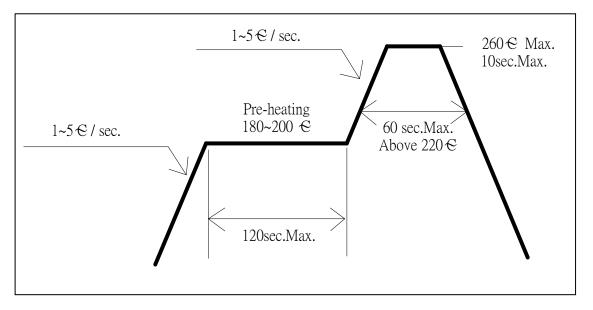


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Soldering Conditions

	Reflow Soldering	Han	Hand Soldering			
Pre-Heat	$180 \sim 200^{\circ} C$					
Pre-Heat Time	120 sec. Max.					
Peak temperature	260°C Max.	Temperature	350°C Max.			
Dipping Time	10 sec. Max.	Soldering time	3 sec. Max.			
Condition	Refer to Temperature-profile		(one time only)			

• Reflow Soldering Condition(Lead-free Solder)



*Recommended soldering conditions vary according to the type of LED

*Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.

*A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

•All SMD LED products are pb-free soldering available.

• Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.

• Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable

double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.





RVE PRECAUTIONS TROSTATIC

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Cautions:

1. After open the package, the LED's floor life is 4 Weeks under 30° C or less and 60%RH or less(MSL:2a).

2. Heat generation must be taken into design consideration when using the LED.

3. Power must be applied resistors for protection, over current would be caused the optic damage to the devices and wavelength shift.

4. Manual tip solder may cause the damage to Chip devices, so advised that heat of iron should be lower than 15W with temperature control under 5 seconds at 230-260 deg. C.(The device would be got damage in re working process, recommended under 5 seconds

at 230-260 deg. C)

5. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LED.

6. Use IPA as a solvent for cleaning the LED. The other solvent may dissolve the LED package and the epoxy, Ultrasonic cleaning should not be done.

7. Damaged LED will show unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LED get unlight at low current.

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